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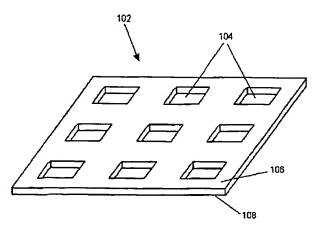
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For two-letter codes and other abbreviations, refer to the "Guidance Notes on Codes and Abbreviations" appearing at the beginning of each regular issue of the PCT Gazette.

(54) Title: MICROELECTRONIC SUBSTRATE WITH INTEGRATED DEVICES



(57) Abstract: A microelectronic substrate including at least one microelectronic die disposed within an opening in a microelectronic substrate core, wherein an encapsulation material is disposed within portions of the opening not occupied by the microelectronic dice, or a plurality microelectronic dice encapsulated without the microelectronic substrate core. Interconnection layers of dielectric materials and conductive traces are then fabricated on the microelectronic die, the encapsulation material, and the microelectronic substrate core (if present) to form the microelectronic substrate.





INTERNATIONAL SEARCH REPORT

Inter Ial Application No PCT/US 01/31438

A. CL	ASSIFIC	ATION C	F SUB	JECT	MATTER
IPC	7	H01L2	23/5:	38	

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Documentation searched other than minimum documentation to the extent that such documents are included. In the fields searched

Electronic data base consulted during the international search (name of data base and, where practical, search terms used)

EPO-Internal, WPI Data, PAJ

Category •	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	US 5 048 179 A (SHINDO MASAHIRO ET AL) 17 September 1991 (1991-09-17) abstract; figures 1,15-18	1-18, 21-28,31
A	column 1, line 35 -column 2, line 33 column 3, line 20 -column 8, line 53 claims 5-17	19,20, 29,30
x	US 5 998 859 A (HO CHUNG WEN ET AL) 7 December 1999 (1999-12-07) abstract; figures 1,2 column 4, line 35 -column 7, line 36 claims 1-4	1-15,21
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Y Further documents are listed in the continuation of box C.	Patent family members are listed in annex.
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Date of the actual completion of the International search 7 May 2003	Date of mailing of the International search report 28/05/2003
Name and malling address of the ISA European Patent Office, P.B. 5818 Patentiaan 2 NL - 2280 HV Rijswijk Tel. (+31-70) 340-2040, Tx. 31 651 epo nl, Fax: (+31-70) 340-3016	Authorized officer Favre, P

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Inter 1st Application No
PCT/US 01/31438

C.(Continua	tion) DOCUMENTS CONSIDERED TO BE RELEVANT	PC1/US 01/31438
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